

## SILICON LDMOS MICROWAVE POWER TRANSISTOR 150 W, up to 500 MHz, Enhancement Mode

Designed for broadband commercial and industrial applications with frequencies from to 500 MHz.

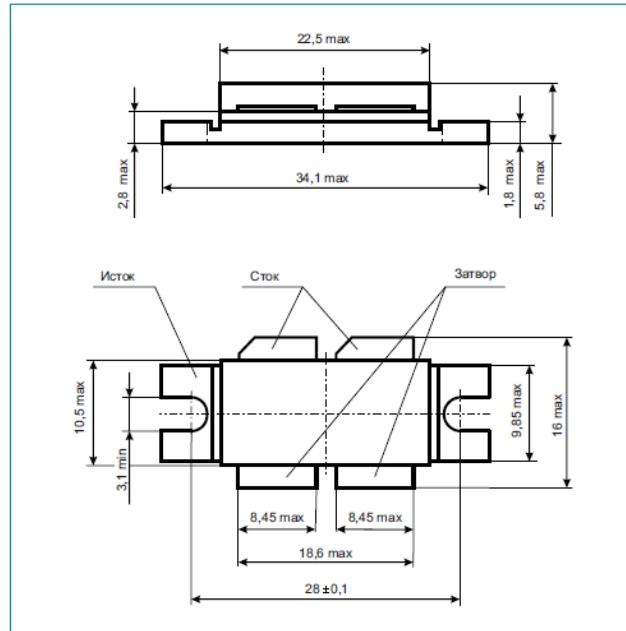
### Features:

- Power Gain: 16 dB Min
- Output Power: 150 W
- Efficiency: 65 % Min

### Absolute Maximum Ratings

Parameters	Sym	Value	Unit
Drain-Source Voltage	V <sub>DSS</sub>	65	V <sub>DC</sub>
Drain Current-Continuous	I <sub>D</sub>	14	A <sub>DC</sub>
Gate-Source Voltage	V <sub>GS</sub>	-0.5, +20	V <sub>DC</sub>
Operation Junction Temperature	T <sub>j</sub>	-65 ÷ +200	°C
Storage Temperature Range	T <sub>STG</sub>	-65 ÷ +150	°C
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.7	°C /W
Total Power Dissipation	P <sub>D</sub>	250	W

KT-103A-1



### Parameters

Parameter	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage (I <sub>DS</sub> =20 mA, V <sub>GS</sub> =0 V)	V <sub>(BR)DSS</sub>	65	—	—	V <sub>DC</sub>
Gate-Source Leakage Current (V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V) <sup>(1)</sup>	I <sub>GSS</sub>	—	—	2	μA <sub>DC</sub>
Zero Gate Voltage Drain Leakage Current (V <sub>DS</sub> = 28 V, V <sub>GS</sub> =0 V) <sup>(1)</sup>	I <sub>DSS</sub>	—	—	1	mA <sub>DC</sub>
Gate Threshold Voltage (V <sub>DS</sub> = 10 V, I <sub>D</sub> = 100 mA)	V <sub>GS(TH)</sub>	2	—	5	V <sub>DC</sub>
Forward Transconductance (V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1.5 A) <sup>(1)</sup>	G <sub>FS</sub>	—	3.0	—	mhos
Drain-Source on-state resistance (V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.0 A) <sup>(1)</sup>	R <sub>DSon</sub>	—	0.2	—	Ω
Dynamic Characteristics					
Input Capacitance (V <sub>DS</sub> = 28 V, V <sub>GS</sub> =0 V, f = 1 MHz) <sup>(1)</sup>	C <sub>ISS</sub>	—	75	—	pF
Output Capacitance (V <sub>DS</sub> = 28 V, V <sub>GS</sub> =0 V, f = 1 MHz) <sup>(1)</sup>	C <sub>OSS</sub>	—	50	—	pF
Reverse Transfer Capacitance (V <sub>DS</sub> = 28 V, V <sub>GS</sub> =0 V, f = 1 MHz) <sup>(1)</sup>	C <sub>RSS</sub>	—	1.7	—	pF
Functional Characteristics					
Power Gain (V <sub>DS</sub> = 28 V, P <sub>OUT</sub> = 80 W, I <sub>DQ</sub> = 100 mA, f = 500 MHz)	G <sub>p</sub>	16	17	—	dB
Drain Efficiency (V <sub>DS</sub> = 28 V, P <sub>OUT</sub> = 80 W, I <sub>DQ</sub> = 100 mA, f = 500 MHz)	η <sub>D</sub>	65	68	—	%

1. Each side of device measured separately.

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